

SECOND CALL FOR PAPERS – <http://www.ieee-icce.org>

General Co-Chairs

- Phuoc Tran-Gia, University of Wuerzburg, Germany
- Saewoong Bahk, Seoul National University, KICS president
- Nguyen Xuan Quynh, National Committee for Professor Titles, Vietnam
- Jan Van der Spiegel, University of Pennsylvania, USA

Technical Program Co-Chairs

- Sang-Gug Lee, KAIST, Korea
- Matthias Paetzold, University of Agder, Norway
- Alan Marshall, University of Liverpool, UK

IMPORTANT DATES

Submission deadline:
August 30th, 2020
Acceptance notification:
October 4th, 2020
Camera ready:
October 11th, 2020
Early bird registration:
October 23rd, 2020
Conference date:
January 13th – 15th, 2021

VENUE:

Novotel Phu Quoc Resort, Phu Quoc Island, Vietnam

CONFERENCE OFFICIAL ADDRESS:

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Important Notice:

Due to the Covid-19 pandemic, the conference date has been shifted to Jan 13th – 15th 2021. Therefore, the second call for paper is being launched to open another opportunity for researchers to submit their research work to a high quality and prestigious IEEE conference.

The 8th IEEE ICCE 2020 which has been renamed as IEEE ICCE 2021 from now on looks for significant contributions to various topics in communications engineering, networking, microwave engineering, signal processing, and electronic engineering. The conference will also include tutorials, workshops, and technology panels given by world-class speakers.

SUBMISSION AND PUBLICATIONS

All authors should prepare full version of papers with maximum length of 6 pages and submit via EDAS: <https://edas.info/N26629>. Full accepted papers will be published in the IEEE ICCE 2021 Conference Proceedings and submitted for inclusion in IEEE Xplore®. The proceedings of ICCE series is regularly indexed by SCOPUS and listed in Conference Proceeding Citation Index (CPCI) of Clarivate.

SCOPE OF THE CONFERENCE

Contributed papers are solicited describing original works in electronics, communication engineering and related technologies. Topics and technical areas of interest include but are not limited to the following:

I. COMMUNICATION NETWORKS AND SYSTEMS

- Networking:** Cloud & Fog/Edge Computing, Networking and Storage; Networking for Big Data; Social Networks; Network Security; IoT and Applications; AI in Networking; Wireless Networks; New Network Architectures, Paradigms and Applications
- Communication Systems:** Coding and Information Theory; UWB; Ultrasonic, Under-Water Communications, Satellite Communications/GNSS; Radio-over-Fiber, Free Space and Fiber-Optic Communications; Software Defined Radio, Cognitive Radio; Cooperative Communications, Secured Communication Systems, Massive MIMO; NOMA, 5G Systems, Energy-Harvesting, Millimeter-Wave Communications, Device-to-Device Communications, Green Communications

II. SIGNAL PROCESSING AND APPLICATIONS

- Image, Video Processing, Analysis and Applications
- Computer Vision Systems and Applications
- Image Based Human-Computer Interaction
- Biomedical Signal Processing and Analysis, Computer-Aided Diagnosis
- Biomedical Applications in Molecular, Structural, and Function Imaging
- PACS and Imaging Informatics
- Smart Hospital and Health Care
- Ambient Intelligence and Applications
- Audio, Acoustic Signal, Speech and Natural Language Processing
- Signal Filtering, Detection and Estimation
- Statistical Signal Processing and Modeling
- Signal Processing in Communications
- Signal and Image Encryption, Multimedia Security

III. MICROWAVE ENGINEERING

- Microwave, Millimeter-Wave Devices/Components Design and Techniques: Passive, Active Devices/Components, Integration Techniques, Nano-Scale Devices, Millimeter-Wave and THz Components
- Antenna and Propagation: Compact Antennas, Reconfigurable and Smart Antennas, Beam Forming, Massive MIMO Antennas, Phased Arrays, Channel Modeling and Propagation
- EM Field Theory and Simulation Techniques: EM Field Theory, Numerical Techniques, Metamaterials, FSSs...
- RF, Microwave and Millimeterwave Systems and Applications: Radar, Sensing and RFID system, Wireless Power Transmission, RF and microwave for healthcare applications
- Other Related Technologies: Nanoscale Integration of Planar, Free-Space, and Mixed Subsystems, 3D Printed RF, RF/microwave applications for Internet of Space (IoS)

IV. ELECTRONIC SYSTEMS

- Electronic Circuits: Analog, Digital, Mixed Signal
- EDA: System Design, Synthesis and Optimization; Formal Methods and Verification
- Architectures and Systems: NoC, Multi-Core, Video and Multimedia, Embedded Systems, Reconfigurable Computing, System-Level Power Management, IoT Devices, Hardware Security, High Performance/Parallel Computing Platforms for Big Data
- Application Systems: Communication, Consumer and Multimedia; Medical and Healthcare; Spacecraft Avionics, Artificial Intelligence, Deep Learning

SPECIAL SESSIONS: IEEE ICCE 2021 offers special sessions, which provide an overview of the state-of-the-art and current research directions on communications and electronics. Please visit <http://www.ieee-icce.org/> for more details.

Post-Conference Publication: Extended versions of the best papers presented at the conference will be considered, by invitation and upon additional review, for publication in: Elsevier's *Physical Communication* (Q2, IF=1,45), Elsevier's *Computer Networks* (Q1, IF=3,03), *EAI Endorsed Transactions on Industrial Networks and Intelligent Systems*, *MDPI Sensors* (Q2, IF=3,03)

